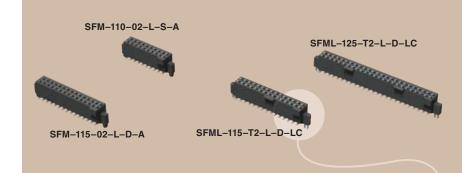


(1,27mm) .050" SFM, SFML SERIES





(1,27mm x 1,27mm)

.050" x .050"

micro pitch

SMT TIGER EYE™ SOCKET

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?SFM or www.samtec.com?SFML

FILE NO. E111594

(SP

Insulator Material: Black Liquid Crystal Polymer
Contact Material:
Tiger Eye™ = BeCu
Tiger Eye™ LITE= Phosphor Bronze Plating:

Au or Šn over 50μ" (1,27μm) Ni Voltage Rating: 350 VAC mated with TFM **Operating Temp Range:** -55°C to +125°C
Contact Resistance:

15 mΩ max Insertion Depth:

(3,05mm) .120" to (4,06mm) .160" Wiping Distance: (0,38mm) .015" Normal Force: Standard= 132g (1,29N) avg.; LIF= 90g (0,88N) avg. Insertion Force (SFM):

Insertion Force (SFM):
(Single contact only)
Standard= 2.5oz (0,69N) avg.;
LITE= 2.0oz (0,56N) avg.;
LIF= 1.4oz (0,39N) avg.
Withdrawal Force (SFM):
(Single contact only)

(Single contact only) Standard= 2.0oz (0,56N) avg.; LITE= 1.5oz (0,42N) avg.; LIF= 1.0oz (0,28N) avg.

Insertion Force (SFML): (Single contact only) 2.5oz (0,69N) avg. Unmating Force (SFML):

Withdrawal force per contact (Single contact only)= 1.5oz (0,42N) average; Incremental unmating force with friction locks: 10-20 pins/row (One Lock) increases withdrawal force by 4 x average; 25 & 30 pins/row (Two Locks) increases withdrawal force by 3 x average 35-50 pins/row (Three Locks) increases withdrawal force by 1.7 x average

Max Cycles: 10,000 with 30μ" (0,76μm) Au **RoHS Compliant:**

Processing: Lead-Free Solderable:

SMT Lead Coplanarity: (0,10mm) .004" max (05-25) (0,15mm) .006" max (30-50)

Note: Other Gold plating options available. Contact Samtec.

Note: Some sizes, styles and options are non-standard, non-returnable



SFML Mates with: TFML, TFSD (-XL option), TFSDT (-XL option)

CURRENT RATING	
AMBIENT TEMP	TFM/SFM
20°C	5A
40°C	4.5A
60°C	3.9A
95°C	2.6A
6 POSITIONS (2x3) POWERED	

ETE CONTACT Locking feature increases d unmating force (SFML)

SMT tails

High reliability

Tiger Eye™ contacts

EXTENDED LIFE PRODUCT 10 year Mixed Flowing Gas with 30µ" Gold 1,000 cycles when mated with TFM APPLICATION SPECIFIC **OPTION**

Solder nail option for (2,36mm) .093" thick board available. Call Samtec.

ТМ

Choice of alignment pin or locking clip options

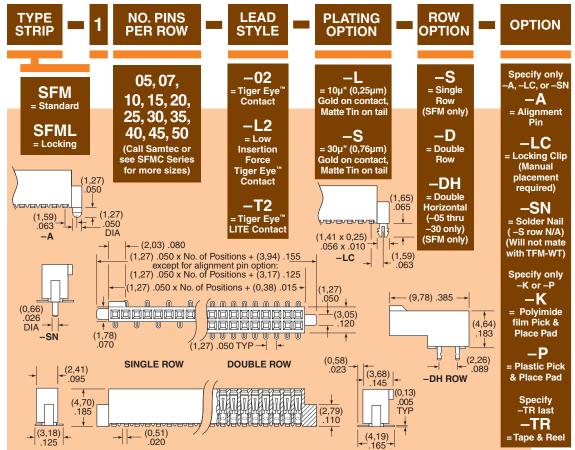
1.27mm SFM/TFM Rated @ 3dB Insertion Loss 6,35mm Stack Height Single-Ended Signaling 6.0 GHz / 12 Gbps Differential Pair Signaling 7.0 GHz / 14 Gbps Performance data for other stack heights and complete

test data available at www.samtec.com?SFM or contact sig@samtec.com



COST-SAVING APPLICATIONS

Lower cost Phosphor Bronze contact (-T2) for applications where Beryllium Copper is not needed. See SFC Series for lower cost plating options.



Due to technical progress, all designs, specifications and components are subject to change without notice.

WWW.SAMTEC.COM